PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 89518

LIN, Mou-Shiung : Confirmation Number: 8665

Application No.: 10/755,042 : Group Art Unit: 2815

Filed: January 9, 2004 : Examiner: JACKSON JR., Jerome

For: INTEGRATED CHIP PACKAGE STRUCTURE USING SILICON SUBSTRATE AND

METHOD OF MANUFACTURING THE SAME

## RESPONSE/AMENDMENT

Mail Stop Amendment Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Attorney Docket No.: 085027-0104

CERTIFICATE OF ELECTRONIC TRANSMISSION
I hereby certify that this correspondence is being electronically-transmitted to the
United States Patent and Trademark Office on December 13, 2010

United States Patent /Nicole San Nicolas/

Nicole San Nicolas

Sir

It is respectfully requested that the time for response to the Office Action dated August 12, 2010, be extended for one month to Monday, December 13, 2010. Please charge the extension fee of \$130.00 to Deposit Account No. 502624. Please charge any additional fees or credit any overpayment to Deposit Account No. 502624.

In response to the Office Action dated August 12, 2010, please amend the aboveidentified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 9 of this paper.

An Appendix is attached after the last page, which shows the status of related cases.